MA4SD10

Silicon epitaxial planar type

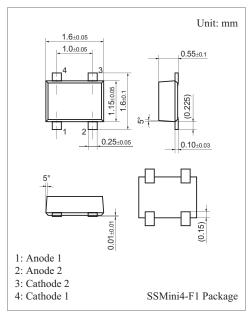
For super-high-speed switching circuits

■ Features

- Two isolated elements are contained in one package, allowing high-density mounting
- Low forward voltage V_F

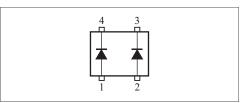
■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse voltage		V_R	20	V	
Repetitive peak reverse voltage		V _{RRM}	20	V	
Forward current (Average)	Single	T	200	mA	
	Double	$I_{F(AV)}$	150		
Peak forward current	Single	T	300	mA	
	Double	I_{FM}	225		
Junction temperature		T _j	125	°C	
Storage temperature		T _{stg}	-55 to +125	°C	



Marking Symbol: M2A

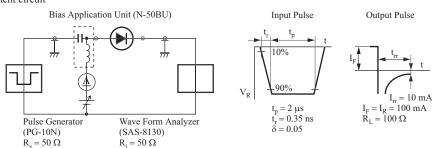
Internal Connection



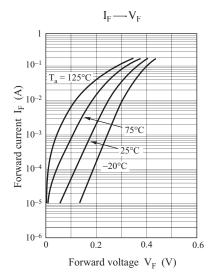
■ Electrical Characteristics $T_a = 25$ °C±3°C

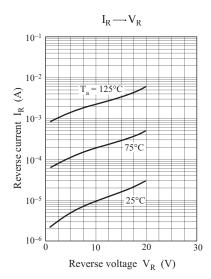
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V_{Fl}	$I_F = 5 \text{ mA}$			0.27	V
	V_{F2}	$I_F = 100 \text{ mA}$			0.40	
	V_{F3}	$I_F = 200 \text{ mA}$			0.47	
Reverse current	I_R	$V_{R^l} = 10 V$			20	μΑ
Terminal capacitance	C _t	$V_{RJ} = 0 \text{ V, } f = 1 \text{ MHz}$		25		pF
Reverse recovery time *	t _{rr}	$I_F = I_{Rl} = 100 \text{ mA}, I_{rr} = 10 \text{ mA}$ $R_{Ll} = 100 \Omega$		3		ns

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. Absolute frequency of input and output is $250\ \text{MHz}$
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. *: t_{rr} measurement circuit



MA4SD10 Panasonic





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- Any applications other than the standard applications intended.

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